

M63812P/FP/GP/KP

7-UNIT 300mA TRANSISTOR ARRAY WITH CLAMP DIODE

DESCRIPTION

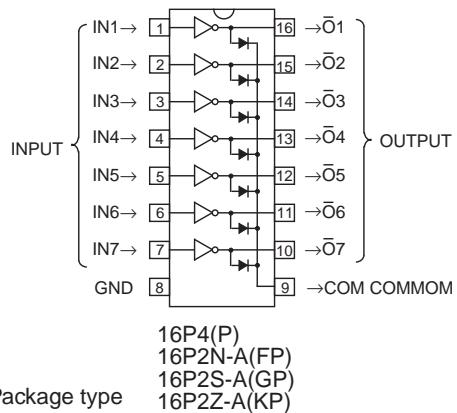
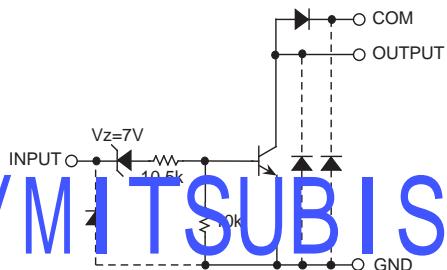
M63812P, M63812FP, M63812GP and M63812KP are seven-circuit Single transistor arrays with clamping diodes. The circuits are made of NPN transistors. Both the semiconductor integrated circuits perform high-current driving with extremely low input-current supply.

FEATURES

- Four package configurations (P, FP, GP and KP)
- Medium breakdown voltage ($BV_{CEO} \geq 35V$)
- Synchronizing current ($I_c(\max) = 300mA$)
- With clamping diodes
- With zener diodes
- Low output saturation voltage
- Wide operating temperature range ($T_a = -40$ to $+85^{\circ}C$)

APPLICATION

Driving of digit drives or indication elements (LEDs and lamps) with small signals

PIN CONFIGURATION**CIRCUIT DIAGRAM**

The seven circuits share the COM and GND.

The diode, indicated with the dotted line, is parasitic, and cannot be used.

Unit: Ω

FUNCTION

The M63812P, M63812FP, M63812GP and M63812KP each have seven circuits consisting of NPN transistor. A spike-killer clamping diode is provided between each output pin (collector) and COM pin (pin9). The transistor emitters are all connected to the GND pin (pin 8). The transistors allow synchronous flow of 300mA collector current. A maximum of 35V voltage can be applied between the collector and emitter.

ABSOLUTE MAXIMUM RATINGS (Unless otherwise noted, $T_a = -40$ ~ $+85^{\circ}C$)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CEO}	Collector-emitter voltage	Output, H	-0.5 ~ +35	V
I_c	Collector current	Current per circuit output, L	300	mA
V_i	Input voltage		-0.5 ~ +35	V
I_F	Clamping diode forward current		300	mA
V_R	Clamping diode reverse voltage		35	V
P_d	Power dissipation	$T_a = 25^{\circ}C$, when mounted on board	M63812P	1.47
			M63812FP	1.00
			M63812GP	0.80
			M63812KP	0.78
T_{op}	Operating temperature		-40 ~ +85	$^{\circ}C$
T_{stg}	Storage temperature		-55 ~ +125	$^{\circ}C$

RECOMMENDED OPERATING CONDITIONS (Unless otherwise noted, $T_a = -40 \sim +85^\circ\text{C}$)

Symbol	Parameter	Test conditions	Limits			Unit
			min	typ	max	
Vo	Output voltage		0	—	35	V
Ic	Collector current (Current per 1 circuit when 7 circuits are coming on simultaneously)	M63812P	Duty Cycle no more than 45%	0	—	250
			Duty Cycle no more than 100%	0	—	160
		M63812FP	Duty Cycle no more than 30%	0	—	250
			Duty Cycle no more than 100%	0	—	130
		M63812GP	Duty Cycle no more than 24%	0	—	250
			Duty Cycle no more than 100%	0	—	120
VIN	Input voltage	M63812KP	Duty Cycle no more than 24%	0	—	250
			Duty Cycle no more than 100%	0	—	120

ELECTRICAL CHARACTERISTICS (Unless otherwise noted, $T_a = 25^\circ\text{C}$)

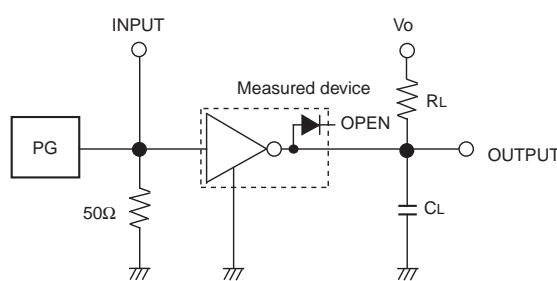
Symbol	Parameter	Test conditions	Limits			Unit
			min	typ	max	
V (BR) CEO	Collector-emitter breakdown voltage	$I_{CEO} = 10\mu\text{A}$	35	—	—	V
VCE(sat)	Collector-emitter saturation voltage	$I_{IN} = 1\text{mA}, I_c = 10\text{mA}$	—	—	0.2	V
		$I_{IN} = 2\text{mA}, I_c = 150\text{mA}$	—	—	0.8	
VIN(on)	"On" input voltage	$I_{IN} = 1\text{mA}, I_c = 10\text{mA}$	13	19	23	V
VR	Clamping diode forward voltage	$I_F = 250\text{mA}$	—	1.2	2.0	V
IR	Clamping diode reverse current	$VR = 35\text{V}$	—	—	10	μA
hFE	DC amplification factor	$V_{CF} = 10\text{V}, I_c = 10\text{mA}$	50	—	—	—

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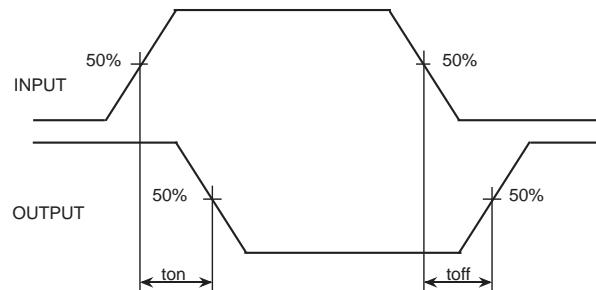
SWITCHING CHARACTERISTICS (Unless otherwise noted, $T_a = 25^\circ\text{C}$)

Symbol	Parameter	Test conditions	Limits			Unit
			min	typ	max	
ton	Turn-on time		—	140	—	ns
toff	Turn-off time	$CL = 15\text{pF}$ (note 1)	—	240	—	ns

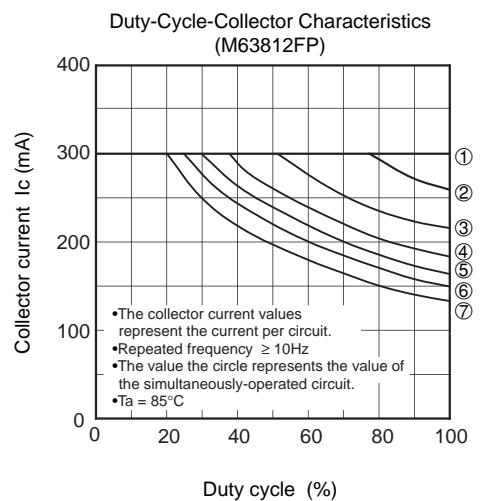
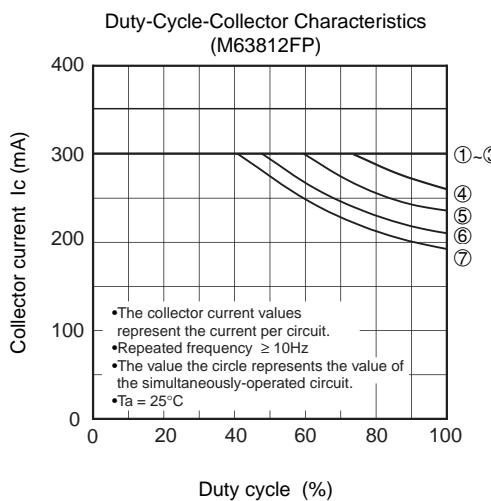
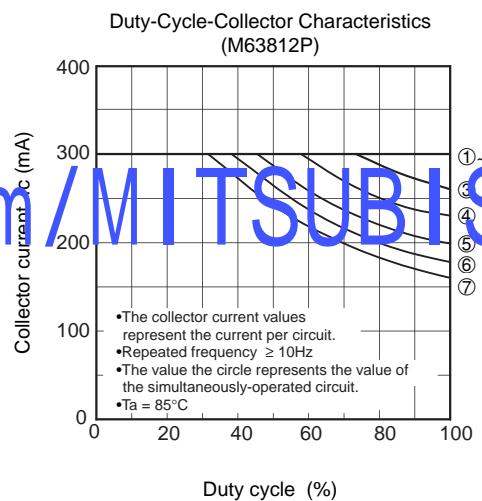
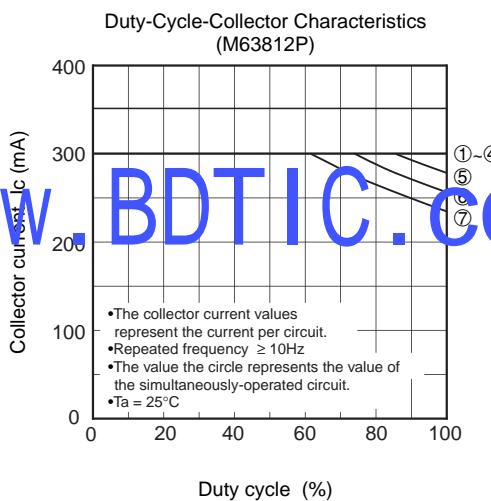
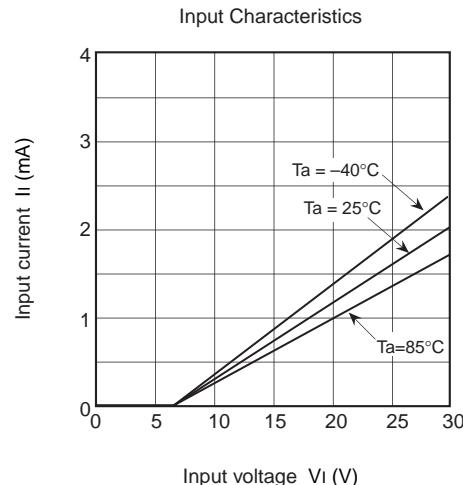
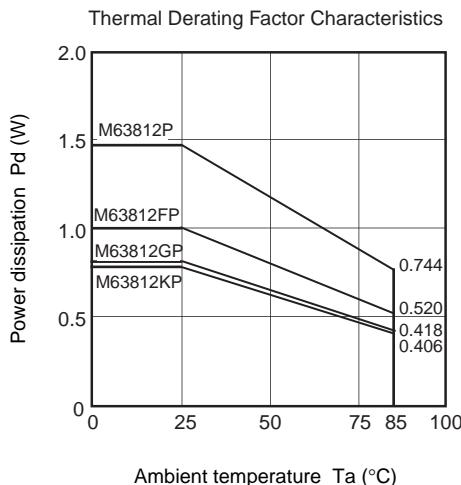
NOTE 1 TEST CIRCUIT

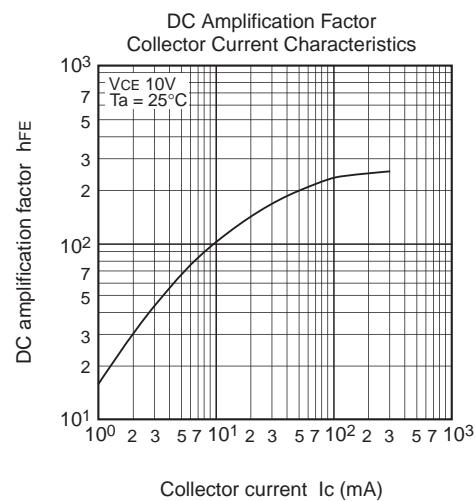
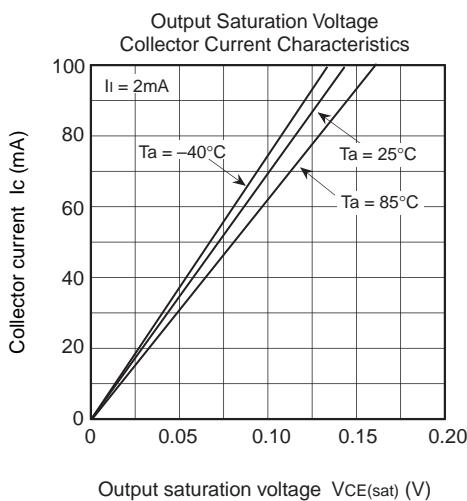
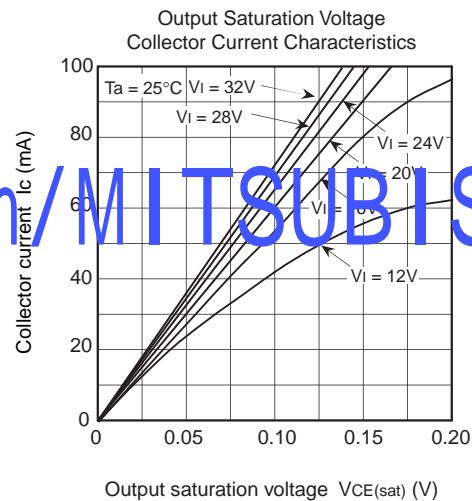
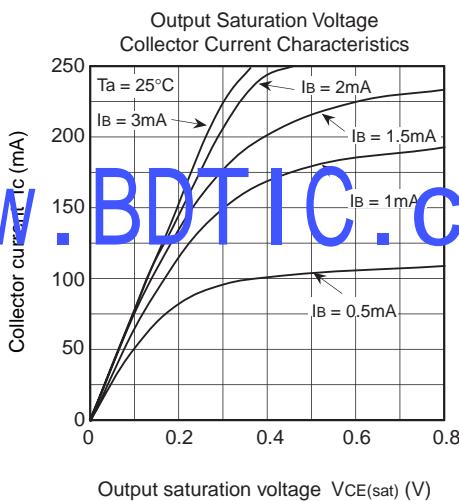
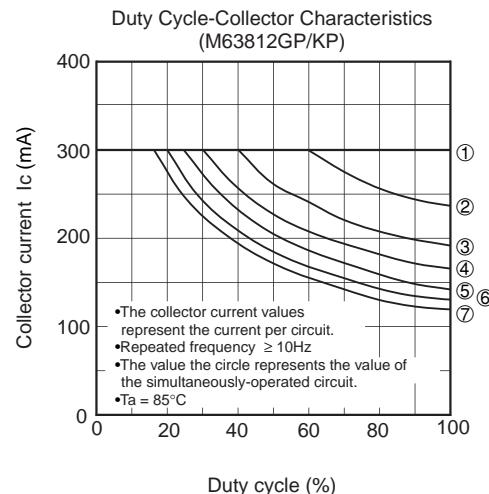
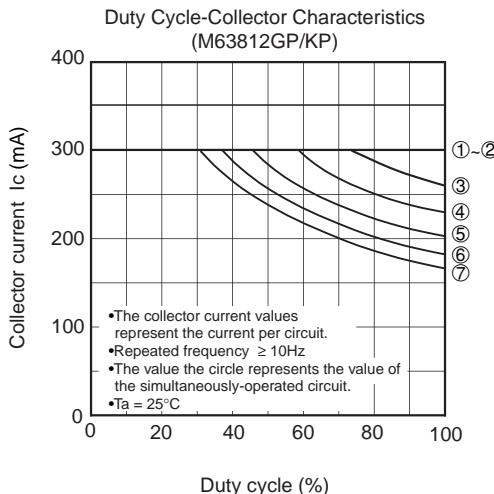


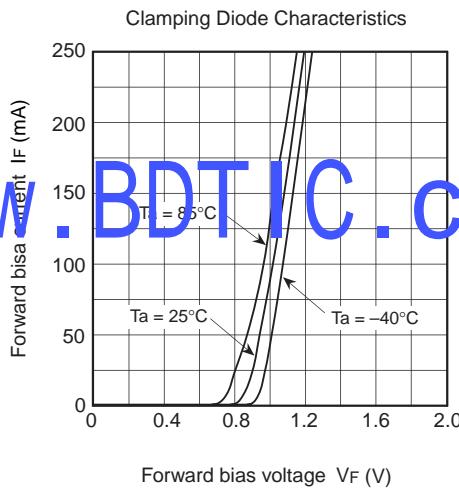
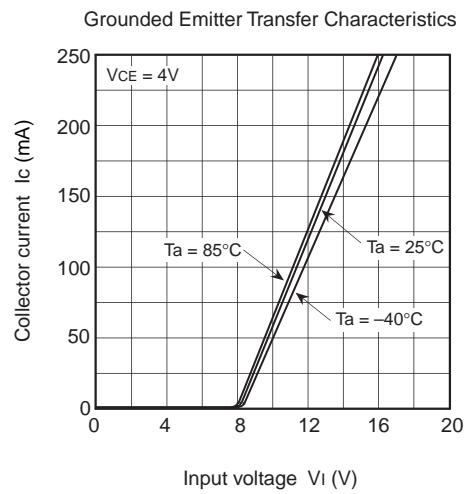
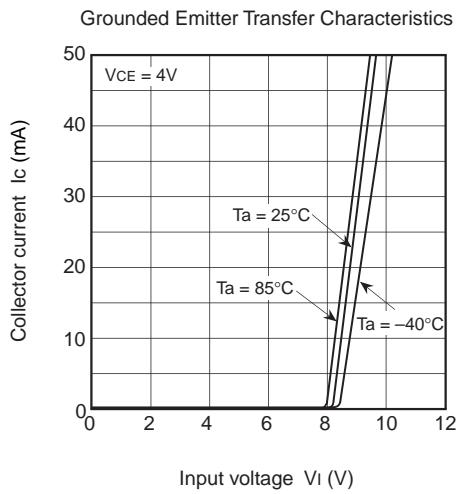
TIMING DIAGRAM



- (1)Pulse generator (PG) characteristics : PRR = 1kHz, $t_w = 10\mu\text{s}$, $t_r = 6\text{ns}$, $t_f = 6\text{ns}$, $Z_0 = 50\Omega$, $V_{IH} = 18\text{V}$
- (2)Input-output conditions : $RL=220\Omega$, $Vo=35\text{V}$
- (3)Electrostatic capacity CL includes floating capacitance at connections and input capacitance at probes

TYPICAL CHARACTERISTICS





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